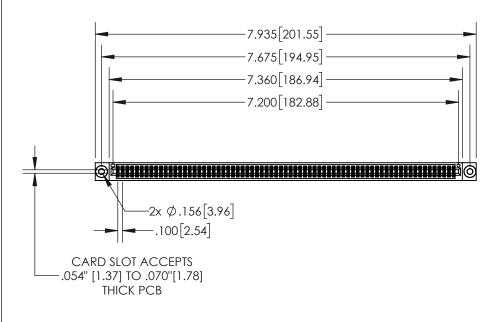
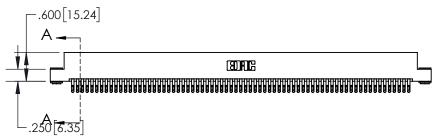
Contact Dimensions:

555-Extender Board Bend (Code 500 Contacts)
See Sheet 2 for Contact Code 555, 556, 558, 559, 560 Dimensions







CARD SLOT .370 9.40 **SECTION A-A** .160 4.06 POINT OF CONTACT −.200^[5.08]

.330[8.38]

- INSULATOR MATERIAL: THERMOPLASTIC, UL 94V-0
- CONTACT MATERIAL; COPPER TIN ALLOY
 CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING
 ON THE CONTACT TAILS, NICKEL UNDERPLATE

845/895 S	ERIES HIGH TEM	CARD	EDGE	CONNECTO	R
PART NUM	MBFR: 895-142-55	55-203			

YOUR CONNECTION TO QUALITY & SERVICE

ACAD REFERENCE NO. 845-ENG-MASTER					
DRAWN: R.STA.MONICA	DATE:MAY.16/2017				
CHECKED:	DATE:				
SCALE: 1:2	SHEET 1 OF 2				
DRAWING NUMBER	ISSUE				

845-ENG-MASTER







INSULATOR MATERIAL: THERMOPLASTIC POLYESTER, UL 94V-0 DAP MATERIAL AVAILABLE UPON REQUEST

Contact Code 558

CONTACT MATERIAL; COPPER ALLOY CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

845/895 SERIES HIGH TEMP CARD EDGE CONNECTOR CONTACT CODE 555,556,558,559,560 DIMENSIONS

YOUR CONNECTION TO QUALITY & SERVICE

Contact Code 559

	ACAD REFERENCE NO	. 845-ENG-MASTER
	DRAWN: R.STA.MONICA	DATE:MAY.16/2017
	CHECKED:	DATE:
	SCALE: 1:1	SHEET 2 OF 2
D	DRAWING NUMBER	ISSUE

Contact Code 560

845-ENG-MASTER